	Туре	L#	Hits	Search Text	DBs	Time Stamp	Comments	Error Defin ition	Errors
1	BRS	L1	167198	etch\$3 same (heat\$3 with substrate or semiconductor or workpiece)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 15:55			0
2	BRS	L2	22147	etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 15:56			0
3	BRS	L3	4175	mask same etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 15:57			0
4	BRS	L4	432	(mask with (Ti or titanium or Al or aluminum or Ta or tantalum or W or tungsten or cobalt or "Co" or Mo or molybdenum)) same etch\$3 same (heat\$3 with (substrate or semiconductor or workpiece))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 16:01			0
5	BRS	L5	341	4 and @pd<=20001020	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:04			0
6	BRS	L6	123	5 and 438/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15			0
7	BRS	L7	0	(rate with erosion with mask) same heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:03			0
8	BRS	L8	0	slow\$3 with (rate with erosion with mask) same heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:04			0
9	BRS	L9	0	slow\$3 same (rate with erosion with mask) same heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:04			0

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	Туре	L#	Hits	Search Text	DBs	Time Stamp	Comments	Error Defin ition	Errors
10	BRS	L10	18	slow\$3 same (rate with erosion) same heat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	14 U.O.A			0
11	BRS	L11	15	10 and @pd<=20001020	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB				0
12	BRS	L12	74	(erosion adj rate) with temperature	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:07			0
13	BRS	L13	29	(erosion adj rate) with (mask andtemperature)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:07			0
14	BRS	L14	0	(erosion adj rate) with (mask and temperature)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:08			0
15	BRS	L15	9	(erosion adj rate) same (mask and temperature)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/15 18:08			0